

SN74AHC8541

SCLS716-APRIL 2009

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8-BIT INVERTING/NON-INVERTING SCHMITT-TRIGGER BUFFER WITH 3-STATE OUTPUTS

FEATURES

- Operating Range of 2 V to 5.5 V V_{CC}
- 8-Bit Inverting/Non-Inverting Outputs
- 20-Pin Thin Shrink Small-Outline Package [TSSOP (PW)] and 20-Pin Plastic Dual-In-Line Package [PDIP (N)]

Ν	N OR PW PACKAGE (TOP VIEW)										
T/C D1 D2 D3 D4 D5 D6		1 2 3 4 5 6 7	l	J	20 19 18 17 16 15 14		V _{CC} Y1 Y2 Y3 Y4 Y5 Y6				
D7 D8 GND		8 9 10			13 12 11		Y7 Y8 OE				

DESCRIPTION

The SN74AHC8541 8-bit inverting/non-inverting buffers are ideal for driving bus lines or buffer memory address registers. These devices feature inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

All outputs are in the high-impedance state (disabled) when the output-enable (\overline{OE}) input is high. When \overline{OE} is low, the respective gate passes the data from the D input to its Y output.

The T/\overline{C} input selects inverting or non-inverting data transfer. When the T/\overline{C} input is high, it provides non-inverting buffers. When the T/\overline{C} input is low, it provides inverting buffers when they are not in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

	•		
	INPUTS	OUTPUT	
OE	T/C	D	Y
L	Н	Н	Н
L	Н	L	L
L	L	н	L
L	L	L	н
н	Х	х	Z

FUNCTION TABLE (EACH BUFFER)⁽¹⁾

(1) L: Low-level

H: High-level

X: Irrelevant

Z: High-impedance (off)

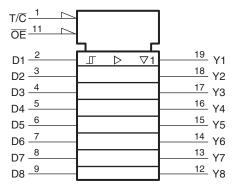


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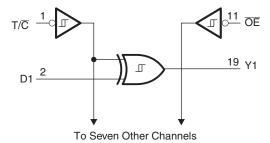


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LOGIC SYMBOL



LOGIC DIAGRAM (POSITIVE LOGIC)



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	7	V
VI	Input voltage range ⁽²⁾	-0.5	7	V	
	Voltage range applied to any output in the	-0.5	7	V	
Vo	Output voltage range applied in the high- o	-0.5	V _{CC} + 0.5	V	
I _{IK}	Input clamp current	V _I < 0 V		-20	V
I _{OK}	Output clamp current	$V_{O} < 0 V \text{ or } VO > V_{CC}$		±50	mA
I _O	Continuous output current	$V_{O} = 0 V \text{ to } V_{CC}$		±25	mA
	Continuous current through V_{CC} or GND			±50	mA
0	Thermelimnedence ⁽⁴⁾	N package		69	°C/W
θ_{JA}	Thermal impedance ⁽⁴⁾	PW package		83	°C/vv
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) This value is limited to 5.5 V maximum.

(4) The package thermal impendance is calculatead in accordance with JESD 51-7.



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RECOMMENDED OPERATING CONDITIONS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT				
V _{CC}	Supply voltage			2	5.5	V				
			$V_{CC} = 2 V$	1.5						
V _{IH}	High-level input voltage		High-level input voltage		High-level input voltage		$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	V _{CC} × 0.7		V
			$V_{CC} = 5 V \pm 0.5 V$	V _{CC} × 0.7						
			$V_{CC} = 2 V$		0.5					
V _{IL}	Low-level input voltage	e	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		V _{CC} × 0.3	V				
			$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$		$V_{CC} \times 0.3$					
VI	Input voltage			0	5.5	V				
	O Output voltage High or low state 3-state		High or lov		High or low st		tate	0	V _{CC}	V
Vo				0	5.5	v				
			$V_{CC} = 2 V$		-50	μA				
I _{OH}	High-level output current		High-level output current		$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-6			
			$V_{CC} = 5 \vee \pm 0.5 \vee$		-12	mA				
			V _{CC} = 2 V		50	μA				
l _{OL}	Low-level output curre	nt	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		6					
			$V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$		12	mA				
		T/C, OE	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	0	100					
A 1 / A \ /	Input transition rise or		$V_{CC} = 5 \vee \pm 0.5 \vee$	0	20	ns/V				
Δt/ΔV	fall rate		V _{CC} = 3.3 V ±0.3 V	0	3					
			$V_{CC} = 5 \vee \pm 0.5 \vee$	0	2	ms/V				
	Dulas reportion time (2))	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	100						
t _{pa}	Pulse reception time ⁽²⁾	reception time ⁽²⁾ $V_{CC} = 5 V \pm 0.5 V$		60		ns				
T _A	Operating free-air tem	perature	· · ·	-40	85	°C				

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.
Buffer inputs D1 to D8 might accept no pulse after t_{pa} period after receiving the first pulse edge. If the input state changes from H to L or L to H in this period, the corresponding output changes from L to H or H to L respectively, in t_{pa} + t_{pd} as delay time in worst-case scenario.

Maximum input frequency, $f_{\text{max}},$ is calculated by the following formula:

 $f_{max} = input pulse duty cycle/(t_{pa(min)} + t_{pd(max)}) when input pulse duty cycle <50\%$ $f_{max} = (1 - input pulse duty cycle)/(t_{pa(min)} + t_{pd(max)}) when input pulse duty cycle >50\%$

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ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	V _{cc}	MIN	TYP ⁽¹⁾	MAX	UNIT
V _{T+}	Positive-going input threshold	D	3.3 V			2.31	V
vT+	voltage	D	5 V			3.5	v
	Negative-going input	D	3.3 V	0.99			V
V _T - threshold voltage		D	5 V	1.5			v
A\/	Hysteresis (V _{T+} – V _{T–})	D	3.3 V	0.33		1.32	V
ΔV _T	$Hysteresis (v_{T+} - v_{T-})$	D	5 V	0.5		2	v
		I _{OH} = -50 μA	2 V	1.9			
V _{ОН}	OH High-level output voltage	I _{OH} = -6 μA	3 V	2.48			V
		I _{OH} = -12 μA	4.5 V	3.8			
		I _{OL} = 50 μA	2 V			0.1	
V _{OL}	Low-level output voltage	I _{OL} = 6 μA	3 V			0.44	V
		I _{OL} = 12 μA	4.5 V			0.55	
I _I	Input current	$V_{I} = 5.5 \text{ V or GND}$	0 V to 5.5 V			±1	μA
l _{oz}	OFF-state output current	$V_{O} = V_{CC}$ or GND	5.5 V			±5	μA
I _{CC}	Supply current	$V_{I} = V_{CC}$ or GND, IO = 0 A	5.5 V			20	μA
CI	Input capacitance	$V_{I} = V_{CC}$ or GND	5 V		3		pF
Co	Output capacitance	$V_{O} = V_{CC}$ or GND	5 V		5		pF
C _{pd}	Power disspation capacitance	f = 1 MHz, no load	5 V		15		pF

(1) All typical values are at $T_A = 25^{\circ}C$.

SWITCHING CHARACTERISTICS

 V_{CC} = 3.3 V ±0.3 V, T_{A} = –40°C to 85°C, see Figure 1

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	MIN	ТҮР	МАХ	UNIT
	D		C _L = 15 pF	1	15	29		
	Dropogotion dology time	D	v	C _L = 50 pF	1	18	34	~~~
t _{pd}	Propagation delay time	T/C	I	C _L = 15 pF	1	16	30	ns
		1/0		C _L = 50 pF	1	20	36	
	Enchla time	ŌĒ	V	C _L = 15 pF	1	9	16	~~~
Len	t _{en} Enable time	UE	ř	C _L = 50 pF	1	11	20	ns
t _{dis} Disable time	Diachla time	ŌĒ	V	C _L = 15 pF	1	8	14	~~~
		UE	r	C _L = 50 pF	1	11	18	ns

SWITCHING CHARACTERISTICS

 V_{CC} = 5 V ±0.5 V, T_{A} = –40°C to 85°C, see Figure 1

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	MIN	ТҮР	МАХ	UNIT
		D		C _L = 15 pF	1	10	16	
	Dranagation dalow time	D	Y	C _L = 50 pF	1	12	20	~~~
t _{pd}	Propagation delay time	T/C	I	C _L = 15 pF	1	11	17	ns
		1/0		C _L = 50 pF	1	13	21	
	Enchla time	ŌĒ	Y	C _L = 15 pF	1	6	10.5	
Len	t _{en} Enable time	ÛE	ř	C _L = 50 pF	1	8	12.5	ns
t _{dis} Disable time	Diachla time	ŌĒ	V	C _L = 15 pF	1	6	10	
		0E	r	C _L = 50 pF	1	8	11.5	ns



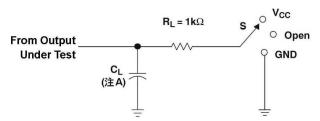
NOISE CHARACTERISTICS⁽¹⁾

$V_{\rm CC} = 5 \rm V,$	$C_{1} = 50$	$pF T_{A} =$	-40°C to	0.85°C
$v_{\rm CC} - J v$,	0 - 30	$p_1, r_A =$	-+0 0 10	0000

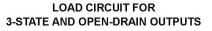
	PARAMETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.4		V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.4		V
V _{OH(V)}	Quiet output, minimum dynamic V _{OH}		4.5		V
V _{IH(D)}	High-level dynamic input voltage	3.5			V
V _{IL(D)}	Lowlevel dynamic input voltage			1.5	V

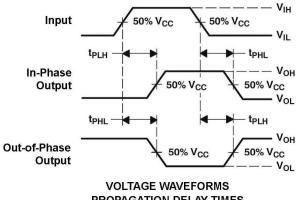
(1) Characteristics are for surface-mount packages only.



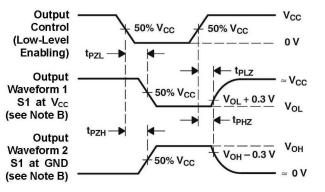


TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	Vcc
t _{PHZ} /t _{PZH}	GND





PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , tr \leq 3 ns, t_f \leq 3 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PZL} and t_{PZH} are the same as t_{en}.
- F. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AHC8541N	ACTIVE	PDIP	Ν	20	20	RoHS & Non-Green	(6) NIPDAU	N / A for Pkg Type	-40 to 85	SN74AHC8541N	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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